

SN54265, SN74265 QUADRUPLE COMPLEMENTARY-OUTPUT ELEMENTS

SDLS088

DECEMBER 1983 — REVISED MARCH 1988

FOR SYMMETRICAL GENERATION OF COMPLEMENTARY TTL SIGNALS

- Switching Time Skew of the Complementary Outputs Is Typically 0.5 ns . . . Not More than 3 ns at Rated Loading
- Full Fan-Out to 20 High-Level and 10 Low-Level 54/74 Loads
- Active Pull-Down Provides Square Transfer Characteristics

description

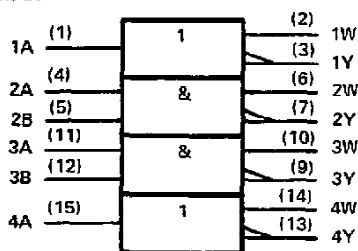
The SN54265 and SN74265 circuits feature complementary outputs from each logic element, which have virtually symmetrical switching time delays from the triggering input. They are designed specifically for use in applications such as:

- Symmetrical clock/clock generators
- Complementary input circuit for decoders and code converters
- Switch debouncing
- Differential line driver

Examples of these four functions are illustrated in the typical application data.

The SN54265 is characterized for operation over the full military temperature range of -55°C to 125°C ; the SN74265 is characterized for operation from 0°C to 70°C .

logic symbol†



†This symbol is in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.

logic diagrams

ELEMENTS 1 and 4



ELEMENTS 2 and 3



positive logic

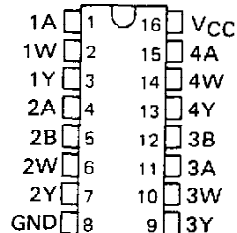
$$Y = \bar{A} \quad W = A$$

$$Y = \overline{AB} \text{ or } Y = \bar{A} + \bar{B}$$

$$W = AB \text{ or } W = \bar{A} + \bar{B}$$

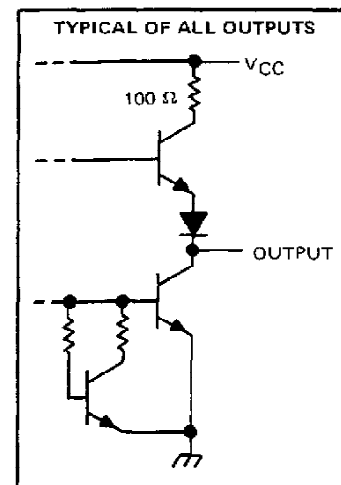
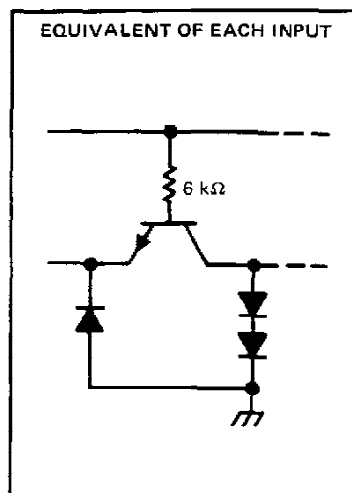
SN54265 . . . J OR W PACKAGE
SN74265 . . . N PACKAGE

(TOP VIEW)



NC No internal connection

schematics of inputs and outputs



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TEXAS
INSTRUMENTS

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SN54265, SN74265 QUADRUPLE COMPLEMENTARY-OUTPUT ELEMENTS

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V_{CC} (see Note 1)	7 V
Input voltage	5.5 V
Operating free-air temperature range: SN54265	-55°C to 125°C
SN74265	0°C to 70°C
Storage temperature range	-65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

	SN54265			SN74265			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, V_{CC}	4.5	5	5.5	4.75	5	5.25	V
High-level output current, I_{OH}			-800			-800	μA
Low-level output current, I_{OL}			16			16	mA
Operating free-air temperature, T_A	-55		125	0		70	$^{\circ}\text{C}$

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS†	MIN	TYP‡	MAX	UNIT
V_{IH} High-level input voltage		2			V
V_{IL} Low-level input voltage				0.8	V
V_{IK} Input clamp voltage	$V_{CC} = \text{MIN}$, $I_I = -12 \text{ mA}$			-1.5	V
V_{OH} High-level output voltage	$V_{CC} = \text{MIN}$, $I_{OH} = -800 \mu\text{A}$	2.4	3.4		V
V_{OL} Low-level output voltage	$V_{CC} = \text{MIN}$, $I_{OL} = 16 \text{ mA}$		0.2	0.4	V
I_I Input current at maximum input voltage	$V_{CC} = \text{MAX}$, $V_I = 5.5 \text{ V}$			1	mA
I_{IH} High-level input current	$V_{CC} = \text{MAX}$, $V_I = 2.4 \text{ V}$			40	μA
I_{IL} Low-level input current	$V_{CC} = \text{MAX}$, $V_I = 0.4 \text{ V}$			-1.6	mA
I_{OS} Short-circuit output current§	$V_{CC} = \text{MAX}$, SN54265	-20		-57	mA
	SN74265	-18		-57	
I_{CC} Supply current	$V_{CC} = \text{MAX}$, See Note 2		25	34	mA

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

‡ All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

§ Not more than one output should be shorted at a time.

NOTE 2: I_{CC} is measured with all outputs open and all inputs grounded.

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$

PARAMETER¶	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
$t_{PLH}(W)$	A or B	W	$R_L = 400 \Omega$, $C_L = 15 \text{ pF}$, See Note 3	11.6	18		ns
$t_{PHL}(Y)$	(as applicable)	Y		11.3	18		
$t_{PHL}(W)$	A or B	W		9.8	18		ns
$t_{PLH}(Y)$	(as applicable)	Y		10.2	18		
$t_{PLH}(W) - t_{PHL}(Y)$	A or B	W with respect to Y		+0.3	± 3		ns
$t_{PHL}(W) - t_{PLH}(Y)$	(as applicable)			-0.4	± 3		

t_{PLH} = propagation delay time, low-to-high-level output

t_{PHL} = propagation delay time, high-to-low-level output

$t_{pXX}(W) - t_{pXX}(Y)$ = Difference in indicated propagation delay times at the W and Y outputs, respectively.

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

TEXAS
INSTRUMENTS

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SN54265, SN74265
QUADRUPLE COMPLEMENTARY-OUTPUT ELEMENTS

TYPICAL CHARACTERISTICS†

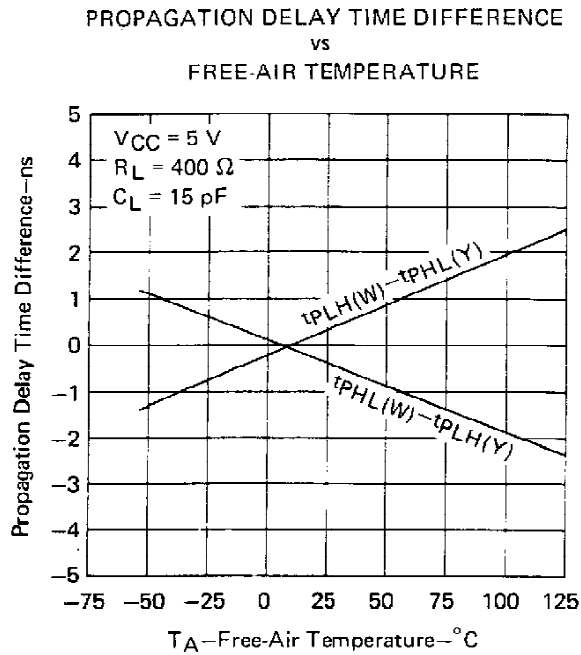


FIGURE 1

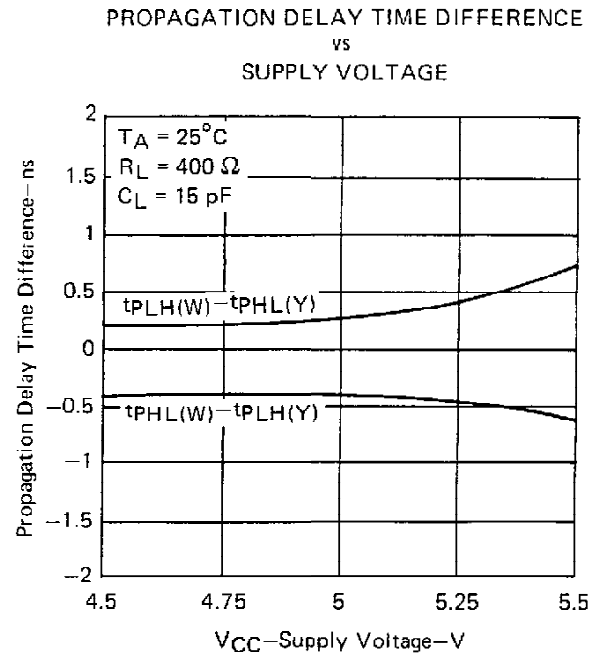


FIGURE 2

PROPAGATION DELAY TIME DIFFERENCE vs LOAD CAPACITANCE

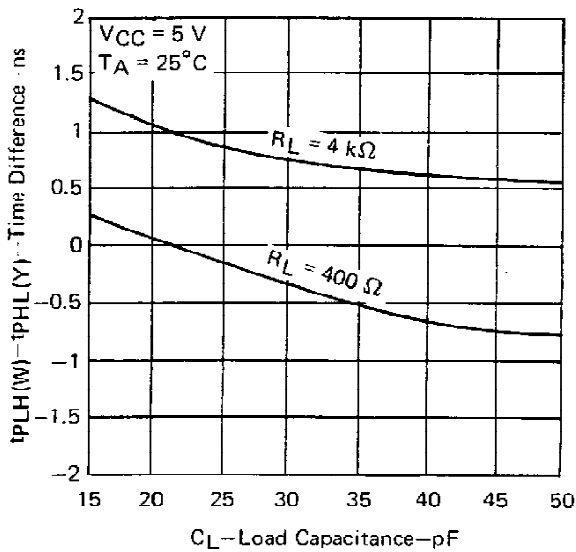


FIGURE 3

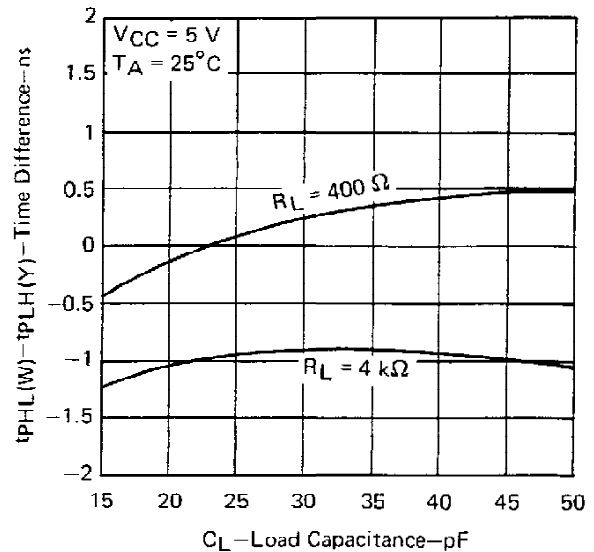


FIGURE 4

† Data for temperatures below 0°C and above 70°C and for supply voltages below 4.75 V and above 5.25 V are applicable for SN54265 only.

SN54265, SN74265 QUADRUPLE COMPLEMENTARY-OUTPUT ELEMENTS

TYPICAL APPLICATION DATA

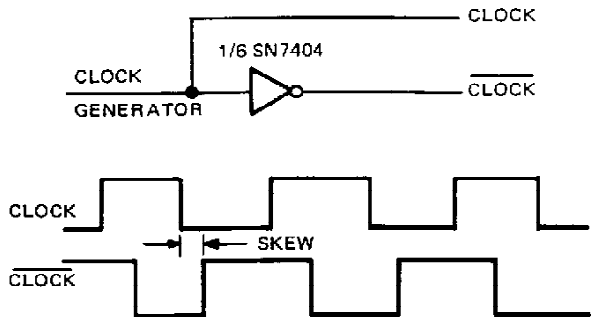


FIGURE A – TYPICAL CLOCK/ $\overline{\text{CLOCK}}$ GENERATOR CIRCUIT

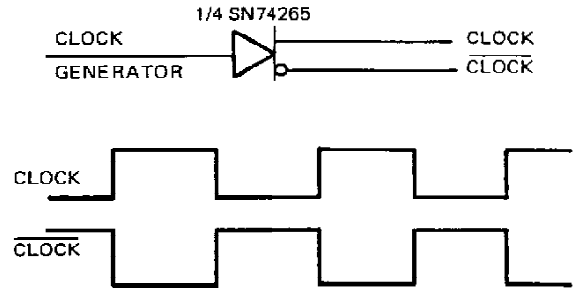


FIGURE B – SKEWLESS CLOCK/ $\overline{\text{CLOCK}}$ GENERATOR CIRCUIT

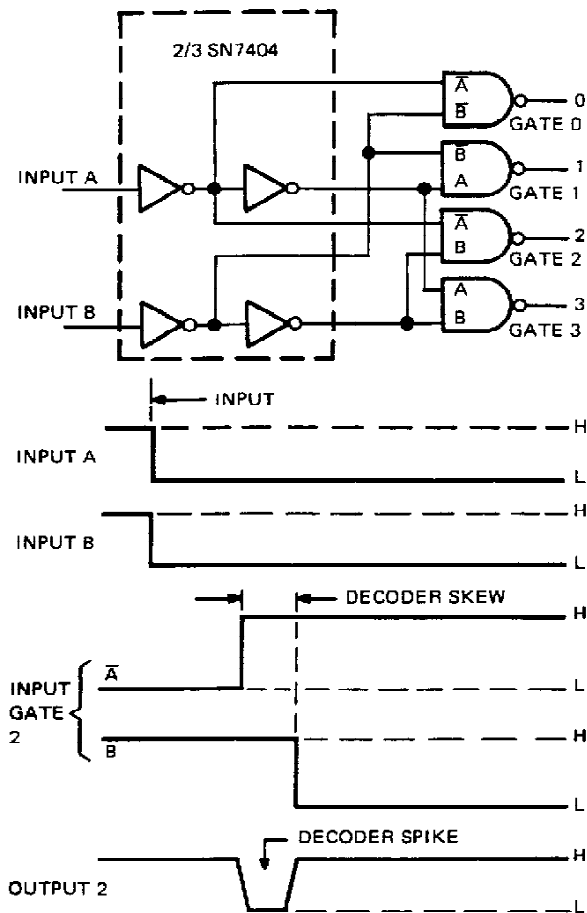


FIGURE C – TYPICAL DECODER/CODE CONVERTER

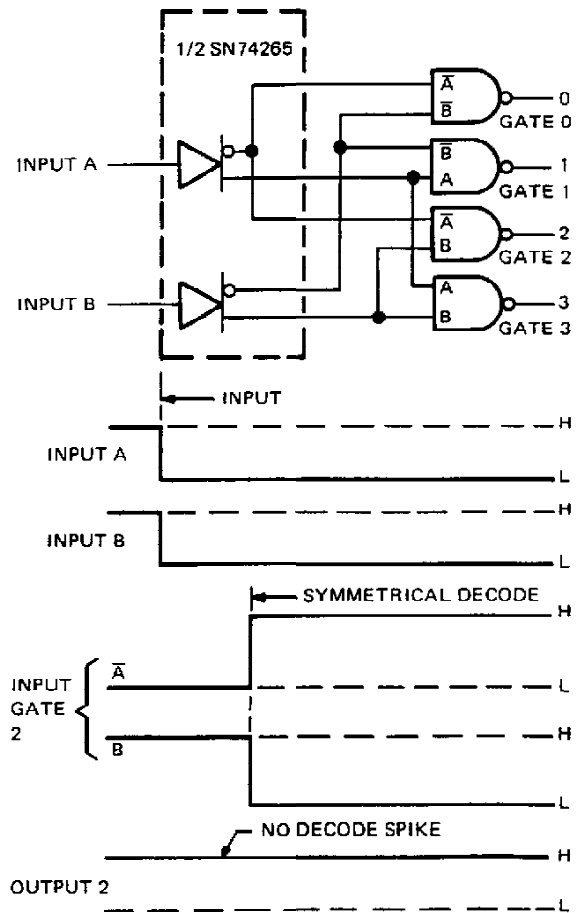


FIGURE D – SYMMETRICAL DECODER/CODE CONVERTER

SN54265, SN74265 QUADRUPLE COMPLEMENTARY-OUTPUT ELEMENTS

TYPICAL APPLICATION DATA

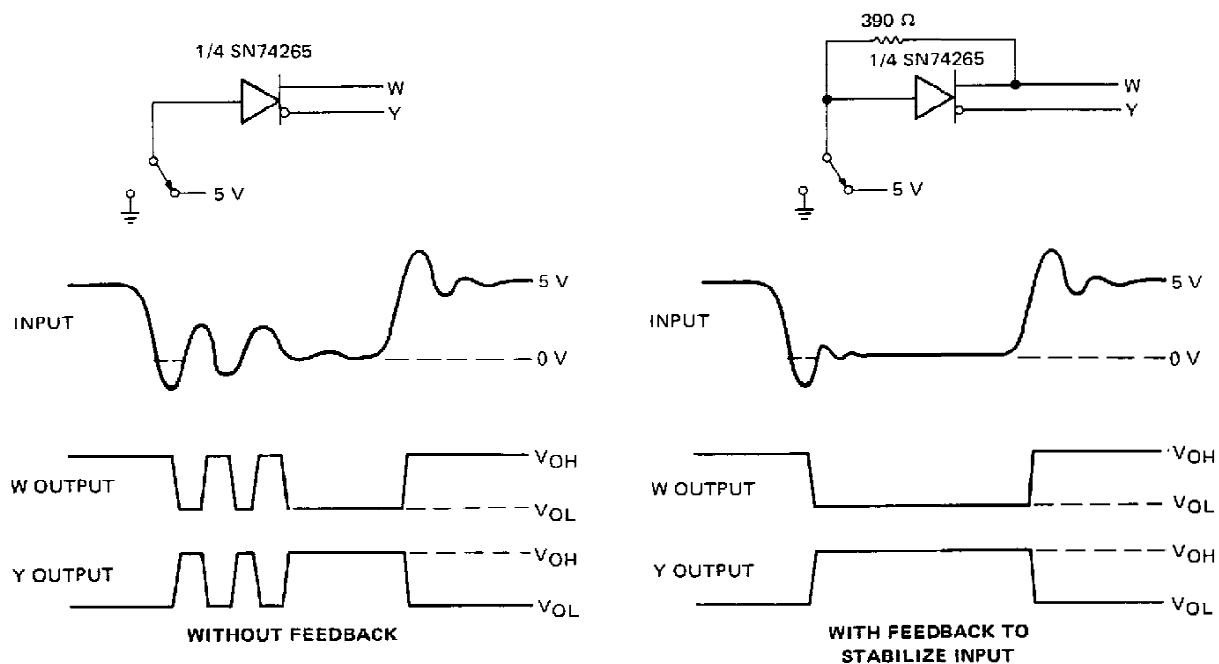


FIGURE E — SWITCH DEBOUNCER

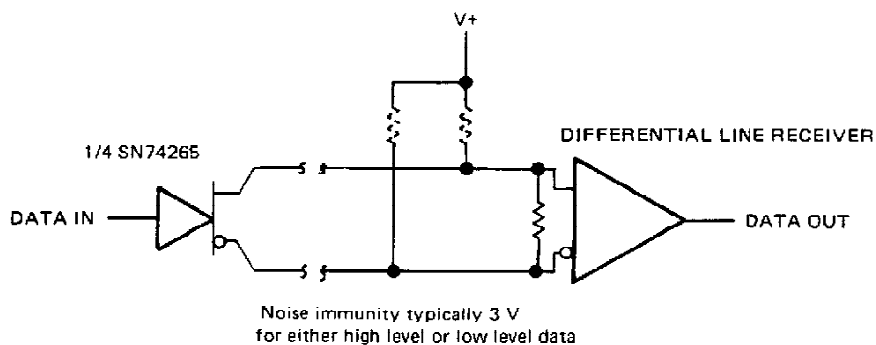


FIGURE F — DIFFERENTIAL LINE DRIVER

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/ Ball Finish	MSL Peak Temp ⁽³⁾	Samples (Requires Login)
SN54265J	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI	Samples Not Available
SN74265N	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI	Samples Not Available
SN74265N3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI	Samples Not Available
SNJ54265J	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI	Samples Not Available

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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OTHER QUALIFIED VERSIONS OF SN54265, SN74265 :

• Catalog: [SN74265](#)

• Military: [SN54265](#)

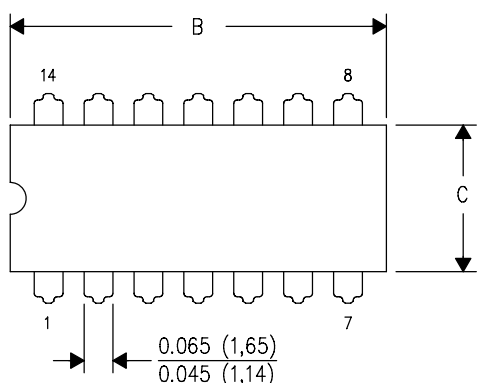
NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product
- Military - QML certified for Military and Defense Applications

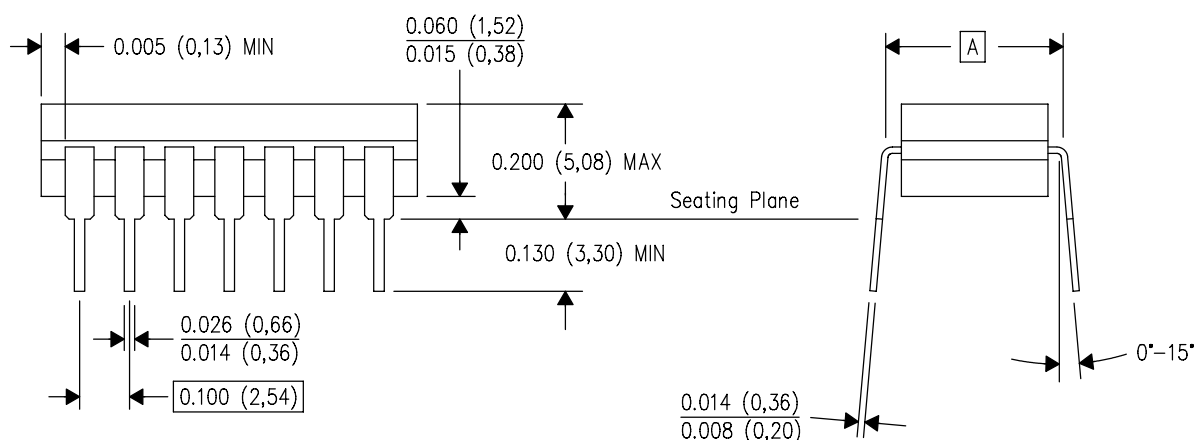
J (R-GDIP-T**)

14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



PINS ** DIM	14	16	18	20
A	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC
B MAX	0.785 (19,94)	.840 (21,34)	0.960 (24,38)	1.060 (26,92)
B MIN	—	—	—	—
C MAX	0.300 (7,62)	0.300 (7,62)	0.310 (7,87)	0.300 (7,62)
C MIN	0.245 (6,22)	0.245 (6,22)	0.220 (5,59)	0.245 (6,22)



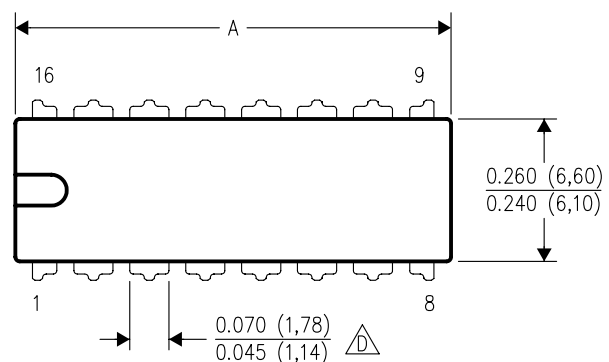
4040083/F 03/03

- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. This package is hermetically sealed with a ceramic lid using glass frit.
 - D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
 - E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

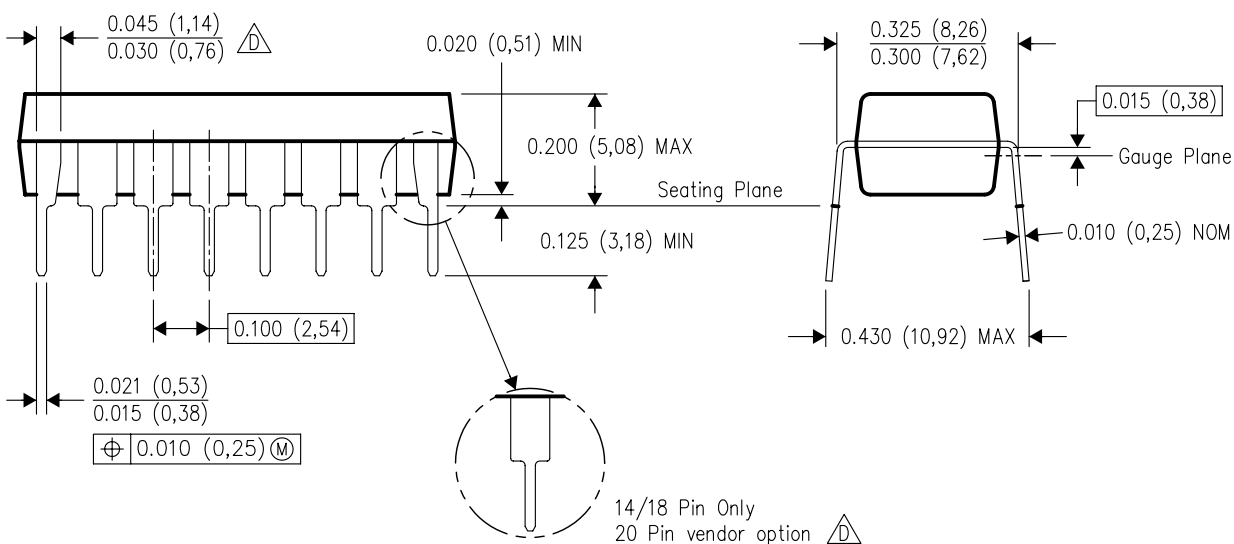
N (R-PDIP-T**)

16 PINS SHOWN

PLASTIC DUAL-IN-LINE PACKAGE



PINS ** DIM	14	16	18	20
A MAX	0.775 (19,69)	0.775 (19,69)	0.920 (23,37)	1.060 (26,92)
A MIN	0.745 (18,92)	0.745 (18,92)	0.850 (21,59)	0.940 (23,88)
MS-001 VARIATION	AA	BB	AC	AD



4040049/E 12/2002

- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 -  Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
 -  The 20 pin end lead shoulder width is a vendor option, either half or full width.

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